
HAT1048R

Silicon P Channel Power MOS FET
Power Switching

HITACHI

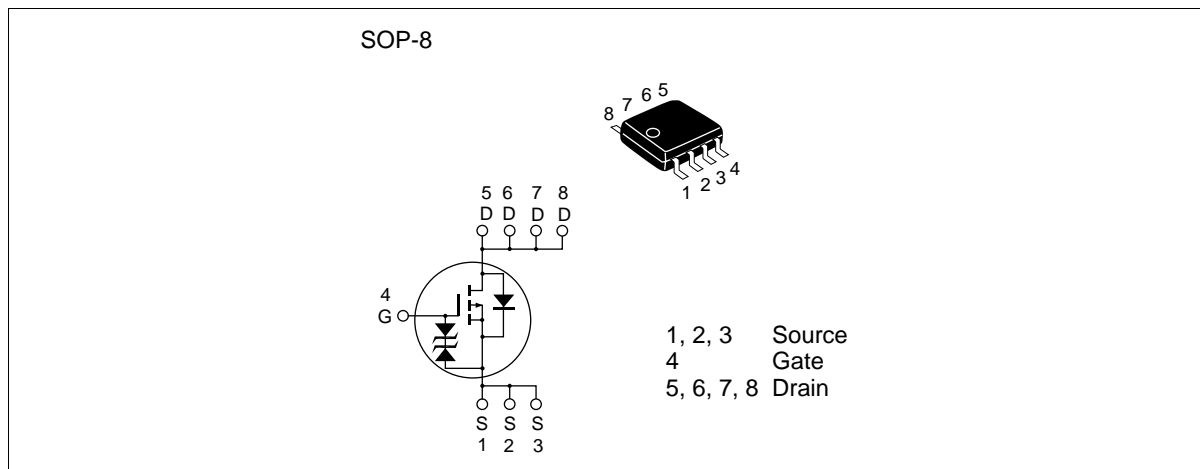
1st Edition
Dec. 1999

Features

- Capable of -4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

$$R_{DS(on)} = 5.5 \text{ m}\Omega \text{ typ} \quad (\text{at } V_{GS} = -10\text{V})$$

Outline



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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	-30	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	-16	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	-128	A
Body-drain diode reverse drain current	I_{DR}	-16	A
Channel dissipation	P_{ch} ^{Note2}	2.5	W
Channel to Ambient Thermal Impedance	θ_{ch-a} ^{Note2}	50	°C/W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	– 55 to + 150	°C

Note: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$
2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), $PW \leq 10s$

Electrical Characteristics (Ta = 25°C)

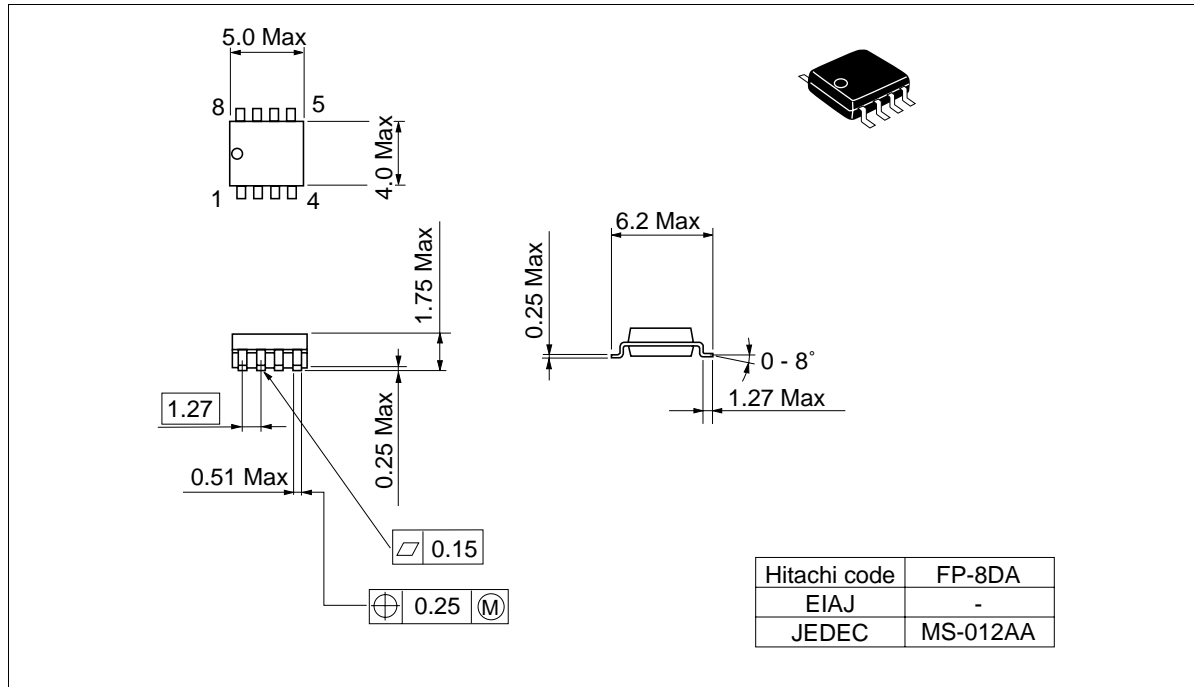
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	—	—	V	$I_D = -10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—	V	$I_G = \pm 100 \text{ }\mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-1	μA	$V_{DS} = -30 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.5	V	$V_{DS} = -10 \text{ V}$, $I_D = -1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	5.5	7.0	$\text{m}\Omega$	$I_D = -8 \text{ A}$, $V_{GS} = -10 \text{ V}$ ^{Note3}
	$R_{DS(on)}$	—	9.5	13.5	$\text{m}\Omega$	$I_D = -8 \text{ A}$, $V_{GS} = -4.5 \text{ V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	(18)	(30)	—	S	$I_D = -8 \text{ A}$, $V_{DS} = -10 \text{ V}$ ^{Note3}
Input capacitance	C_{iss}	—	(5700)	—	pF	$V_{DS} = -10 \text{ V}$
Output capacitance	C_{oss}	—	(1250)	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	(710)	—	pF	$f = 1 \text{ MHz}$
Total gate charge	Q_g	—	(105)	—	nc	$V_{DD} = -10 \text{ V}$
Gate to source charge	Q_{gs}	—	(14)	—	nc	$V_{GS} = -10 \text{ V}$
Gate to drain charge	Q_{gd}	—	(20)	—	nc	$I_D = -16 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	(25)	—	ns	$V_{GS} = -10 \text{ V}$, $I_D = -8 \text{ A}$
Rise time	t_r	—	(100)	—	ns	$V_{DD} = 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	(550)	—	ns	$R_L = 1.25 \text{ }\Omega$
Fall time	t_f	—	(320)	—	ns	$R_g = 4.7 \text{ }\Omega$
Body-drain diode forward voltage	V_{DF}	—	(0.9)	(1.17)	V	$I_F = -16 \text{ A}$, $V_{GS} = 0$ ^{Note3}
Body-drain diode reverse recovery time	t_{rr}	—	(50)	—	ns	$I_F = -16 \text{ A}$, $V_{GS} = 0$ $diF/dt = 50 \text{ A}/\mu\text{s}$

Note: 3. Pulse test

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Package Dimensions

Unit: mm



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